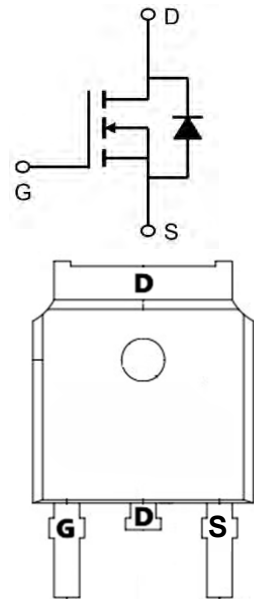


### Description

The LMAK180N03 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



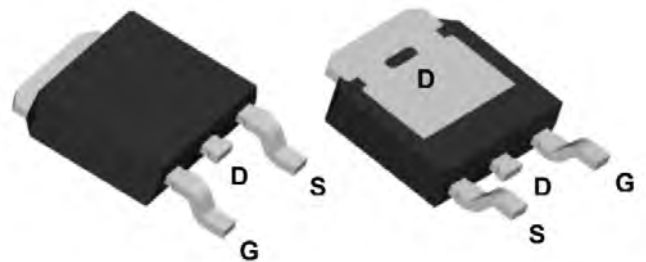
### General Features

$V_{DS}=30V$   $I_D=180A$

$R_{DS(ON)} < 3.2m\Omega$  @  $V_{GS}=10V$  (Typ. **2.1mΩ**)

### Application

- Battery protection
- Load switch
- Uninterruptible power supply



### Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| LMAK180N03     | AP180N03D | TO-252         | -         | -          | 2500     |

### Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise noted)

| Symbol                | Parameter  | Rating     | Units        |
|-----------------------|--|------------|--------------|
| $V_{DS}$              | Drain-Source Voltage                             | 30         | V            |
| $V_{GS}$              | Gate-Source Voltage                              | $\pm 20$   | V            |
| $I_D@T_C=25^\circ C$  | Continuous Drain Current, $V_{GS}$ @ $10V^{1,6}$ | 180        | A            |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $V_{GS}$ @ $10V^{1,6}$ | 145        | A            |
| $I_{DM}$              | Pulsed Drain Current <sup>2</sup>                | 500        | A            |
| EAS                   | Single Pulse Avalanche Energy <sup>3</sup>       | 246        | mJ           |
| $I_{AS}$              | Avalanche Current                                | 70.2       | A            |
| $P_D@T_C=25^\circ C$  | Total Power Dissipation <sup>4</sup>             | 187        | W            |
| $T_{STG}$             | Storage Temperature Range                        | -55 to 175 | $^\circ C$   |
| $T_J$                 | Operating Junction Temperature Range             | -55 to 175 | $^\circ C$   |
| $R_{\theta JA}$       | Thermal Resistance Junction-Ambient <sup>1</sup> | 62         | $^\circ C/W$ |
| $R_{\theta JC}$       | Thermal Resistance Junction-Case <sup>1</sup>    | 0.8        | $^\circ C/W$ |

## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

| Symbol          | Parameter                                      | Conditions  | Min. | Typ.  | Max. | Unit  |
|-----------------|--|---|------|-------|------|-------|
| BVDSS           | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA  | 30   | 38    | ---  | V     |
| ΔBVDSS/ΔTJ      | BV <sub>DSS</sub> Temperature Coefficient      | Reference to 25°C, I <sub>D</sub> =1mA  | ---  | 0.014 | ---  | V/°C  |
| RDS(ON)         | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =10V, I <sub>D</sub> =30A   | ---  | 2.1   | 3.2  | mΩ    |
|                 |  | V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A  | ---  | 3.0   | 3.8  |       |
| VGS(th)         | Gate Threshold Voltage                         | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA                                  | 1.2  | 1.6   | 2.5  | V     |
| ΔVGS(th)        | V <sub>GS(th)</sub> Temperature Coefficient    |   | ---  | -4    | ---  | mV/°C |
| IDSS            | Drain-Source Leakage Current                   | V <sub>DS</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C                           | ---  | ---   | 1    | uA    |
|                 |  | V <sub>DS</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C                           | ---  | ---   | 5    |       |
| IGSS            | Gate-Source Leakage Current                    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V  | ---  | ---   | ±100 | nA    |
| gfs             | Forward Transconductance                       | V <sub>DS</sub> =5V, I <sub>D</sub> =30A  | ---  | 50    | ---  | S     |
| R <sub>g</sub>  | Gate Resistance                                | V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz  | ---  | 1.7   | ---  | Ω     |
| Q <sub>g</sub>  | Total Gate Charge (4.5V)                       | V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =15A                           | ---  | 56.9  | ---  | nC    |
| Q <sub>gs</sub> | Gate-Source Charge                             |   | ---  | 13.8  | ---  |       |
| Q <sub>gd</sub> | Gate-Drain Charge                              |   | ---  | 23.5  | ---  |       |
| Td(on)          | Turn-On Delay Time                             | V <sub>DD</sub> =15V, V <sub>GS</sub> =10V<br>R <sub>G</sub> =3.3Ω,<br>I <sub>D</sub> =1A | ---  | 20.1  | ---  | ns    |
| T <sub>r</sub>  | Rise Time                                      |   | ---  | 6.3   | ---  |       |
| Td(off)         | Turn-Off Delay Time                            |   | ---  | 124.6 | ---  |       |
| T <sub>f</sub>  | Fall Time                                      |   | ---  | 15.8  | ---  |       |
| Ciss            | Input Capacitance                              | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz   | ---  | 5850  | ---  | pF    |
| Coss            | Output Capacitance                             |   | ---  | 720   | ---  |       |
| Crss            | Reverse Transfer Capacitance                   |   | ---  | 525   | ---  |       |
| IS              | Continuous Source Current <sup>1,5</sup>       | V <sub>G</sub> =V <sub>D</sub> =0V, Force Current   | ---  | ---   | 205  | A     |
| ISM             | Pulsed Source Current <sup>2,5</sup>           |   | ---  | ---   | 500  | A     |
| VSD             | Diode Forward Voltage <sup>2</sup>             | V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25°C                             | ---  | ---   | 1.2  | V     |

**Note :**

- 1、 The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3、 The EAS data shows Max. rating . The test condition is VDD=25V,VGS=10V,L=0.1Mh,IAS=22A
- 4、 The power dissipation is limited by 175°C junction temperature
- 5、 The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Typical Characteristics

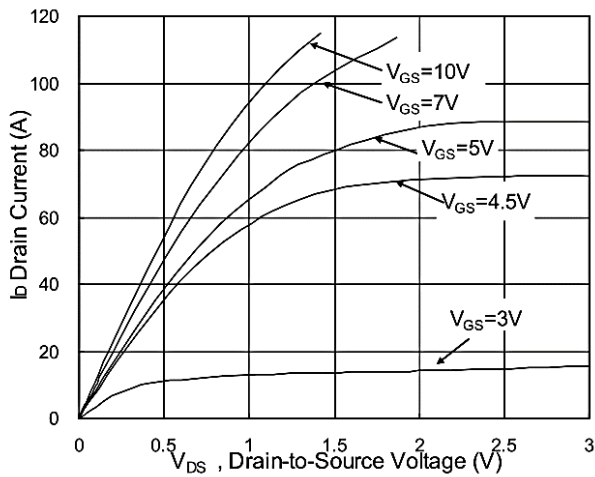


Fig.1 Typical Output Characteristics

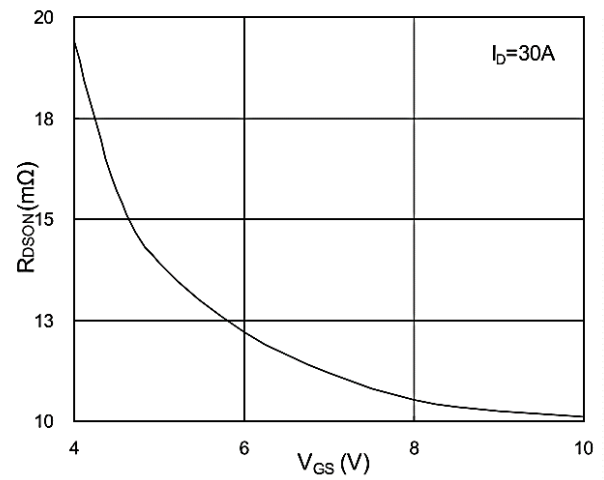


Fig.2 On-Resistance vs. G-S Voltage

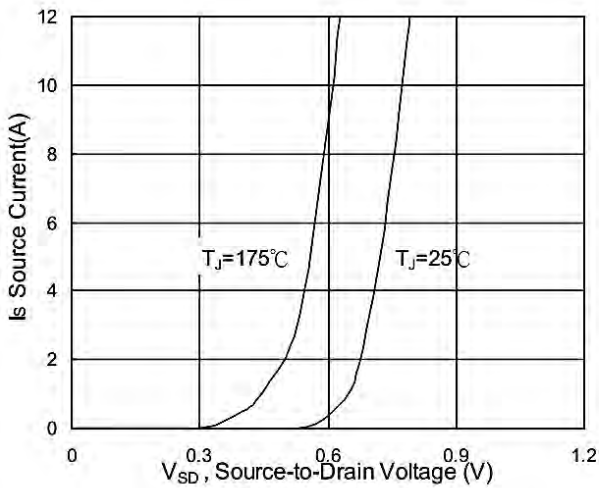


Fig.3 Forward Characteristics of Reverse

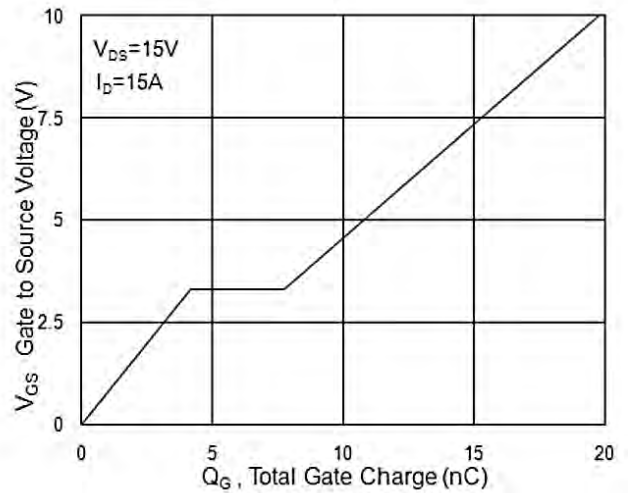


Fig.4 Gate-Charge Characteristics

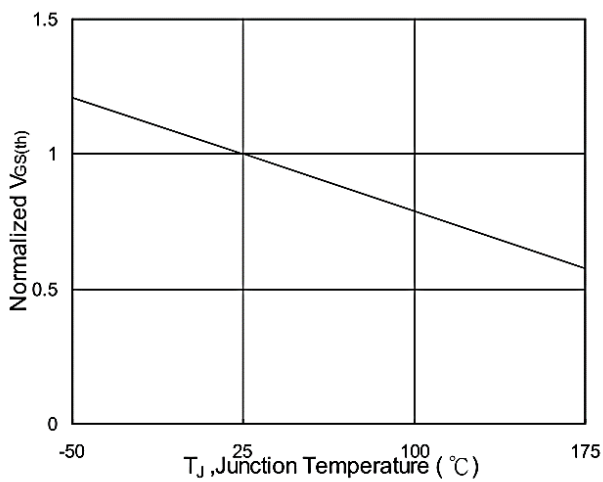


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

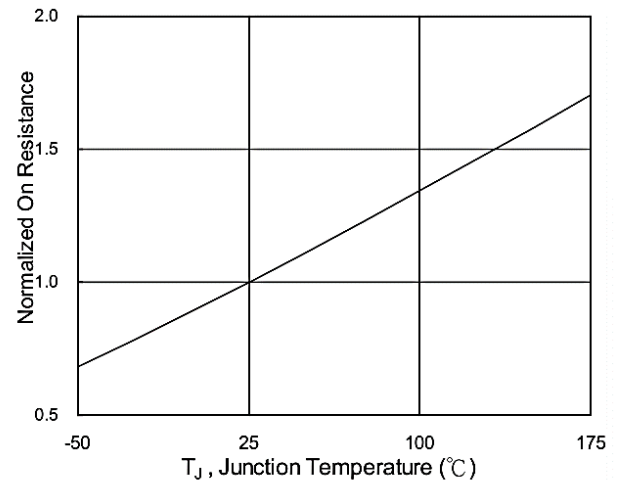


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

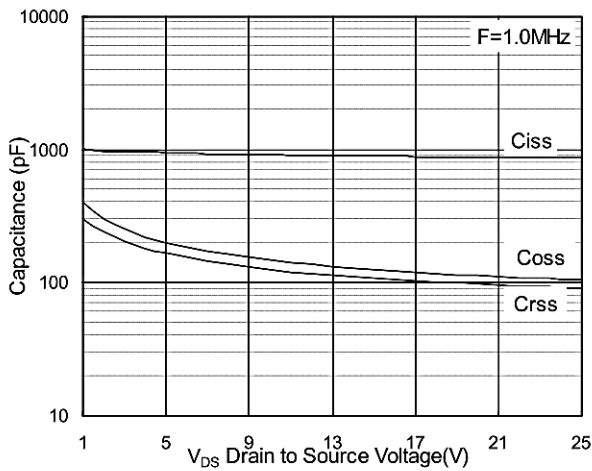


Fig.7 Capacitance

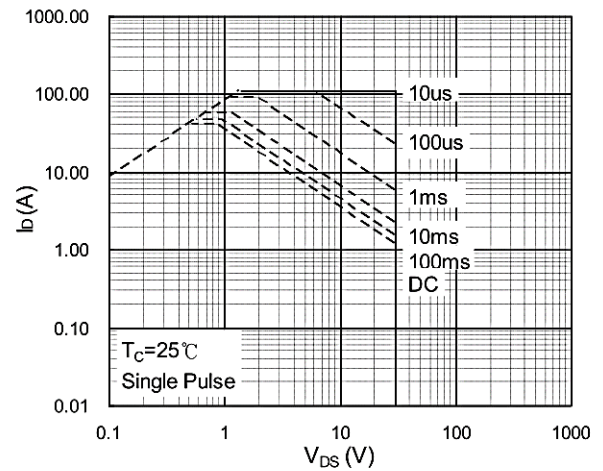


Fig.8 Safe Operating Area

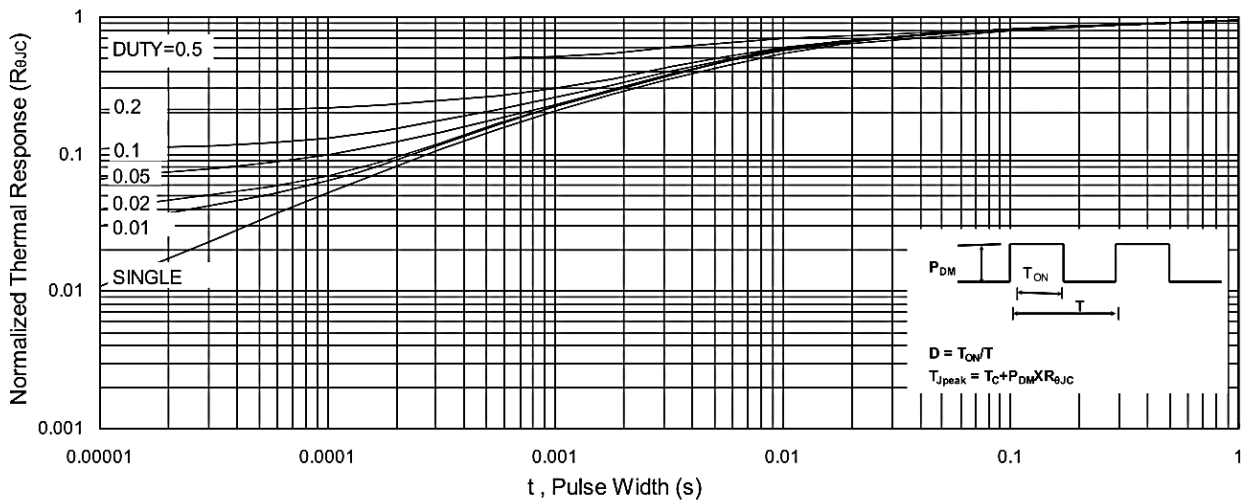


Fig.9 Normalized Maximum Transient Thermal Impedance

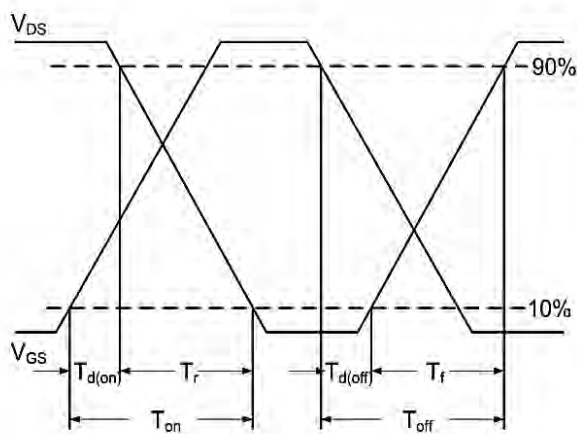


Fig.10 Switching Time Waveform

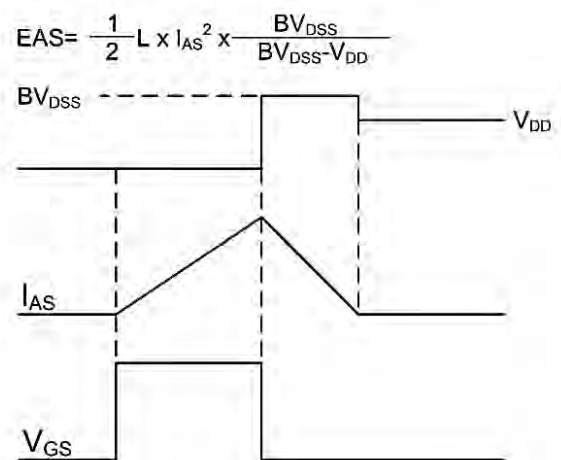
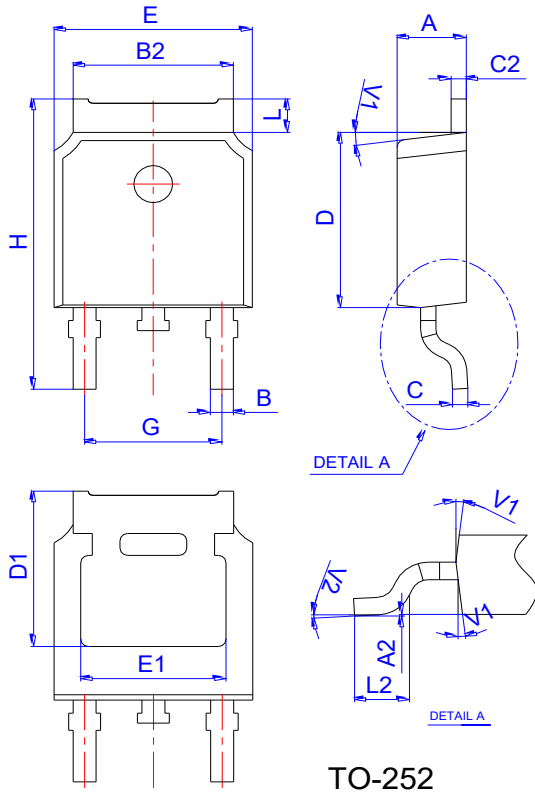


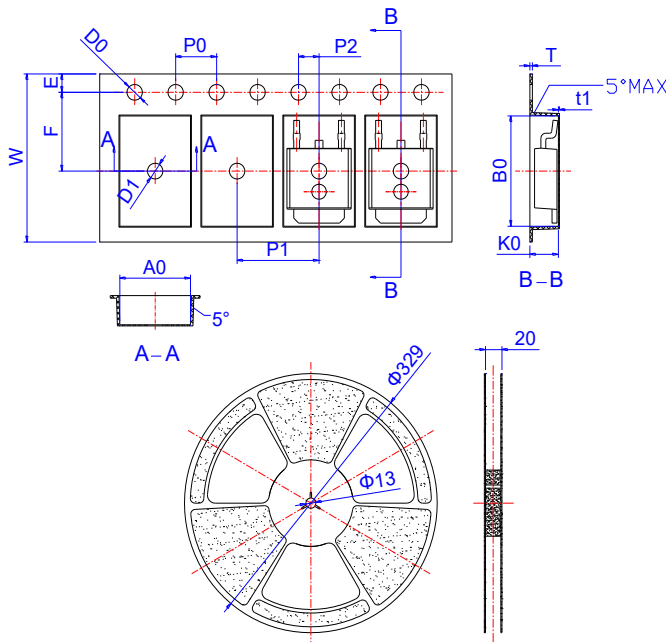
Fig.11 Unclamped Inductive Switching Waveform

### Package Mechanical Data: TO-252



| Ref. | Dimensions  |      |       |          |      |       |
|------|-------------|------|-------|----------|------|-------|
|      | Millimeters |      |       | Inches   |      |       |
|      | Min.        | Typ. | Max.  | Min.     | Typ. | Max.  |
| A    | 2.10        |      | 2.50  | 0.083    |      | 0.098 |
| A2   | 0           |      | 0.10  | 0        |      | 0.004 |
| B    | 0.66        |      | 0.86  | 0.026    |      | 0.034 |
| B2   | 5.18        |      | 5.48  | 0.202    |      | 0.216 |
| C    | 0.40        |      | 0.60  | 0.016    |      | 0.024 |
| C2   | 0.44        |      | 0.58  | 0.017    |      | 0.023 |
| D    | 5.90        |      | 6.30  | 0.232    |      | 0.248 |
| D1   | 5.30REF     |      |       | 0.209REF |      |       |
| E    | 6.40        |      | 6.80  | 0.252    |      | 0.268 |
| E1   | 4.63        |      |       | 0.182    |      |       |
| G    | 4.47        |      | 4.67  | 0.176    |      | 0.184 |
| H    | 9.50        |      | 10.70 | 0.374    |      | 0.421 |
| L    | 1.09        |      | 1.21  | 0.043    |      | 0.048 |
| L2   | 1.35        |      | 1.65  | 0.053    |      | 0.065 |
| V1   |             | 7°   |       |          | 7°   |       |
| V2   | 0°          |      | 6°    | 0°       |      | 6°    |

### Reel Specification



| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| W    | 15.90       | 16.00 | 16.10 | 0.626  | 0.630 | 0.634 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 7.40        | 7.50  | 7.60  | 0.291  | 0.295 | 0.299 |
| D0   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| D1   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 7.90        | 8.00  | 8.10  | 0.311  | 0.315 | 0.319 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| A0   | 6.85        | 6.90  | 7.00  | 0.270  | 0.271 | 0.276 |
| B0   | 10.45       | 10.50 | 10.60 | 0.411  | 0.413 | 0.417 |
| K0   | 2.68        | 2.78  | 2.88  | 0.105  | 0.109 | 0.113 |
| T    | 0.24        |       | 0.27  | 0.009  |       | 0.011 |
| t1   | 0.10        |       |       | 0.004  |       |       |
| 10P0 | 39.80       | 40.00 | 40.20 | 1.567  | 1.575 | 1.583 |

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